### UNITED STATES PATENT AND TRADEMARK OFFICE

### BEFORE THE PATENT TRIAL AND APPEAL BOARD

### TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., Petitioner,

V.

GODO KAISHA IP BRIDGE 1, Patent Owner.

> Case IPR2016-01246<sup>1</sup> Patent 7,126,174 B2

PETITIONER'S MOTION TO EXCLUDE EVIDENCE UNDER 37 C.F.R. § 42.64(c)

<sup>1</sup> Case IPR2016-01247 has been consolidated with this proceeding.

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### I. Introduction

For the reasons discussed below, Petitioner TSMC hereby moves to exclude

the following evidence under 37 C.F.R. § 42.64(c):

Exhibit	Description
2001	Declaration of Dr. E. Fred Schubert, Ph.D. in support of Patent Owner's
2001	Preliminary Response filed in IPR2016-01246 on October 5, 2016
	Schematic illustration of the Chemical Mechanical Polishing process
2002	from Steigerwald, Murarka, and Gutmann, Chemical Mechanical
	Planarization of Microelectronic Materials (1997).
	Schematic illustration of the Chemical Mechanical Polishing process
2003	from the Motorola Company. SCSolutions.com. Accessed September
2003	30, 2016. http://www.scsolutions.com/chemical-
	mechanicalplanarization-cmp-controllers-0
	Photograph of a Chemical Mechanical Polishing Tool from the Applied
	Materials Company. BusinessWire.com. Accessed October 5, 2016.
2004	http://www.businesswire.com/news/home/20040711005007/en/Applied-
	Materials-Revolutionizes-Planarization-Technology-Breakthrough-
	Reflexion
2005	Troxel, Boning, McIlrath "Semiconductor Process Representation."
2003	Wiley Encyclopedia of Electrical and Electronics, pp. 139–147 (1999).
2006	U.S. Patent No. 6,052,319 to Jacobs
2007	U.S. Patent No. 6,952,656 to Cordova et al.
	Hunt, "Low Budget Undergraduate Microelectronics Laboratory."
2008	University Government Industry Microelectronics Symposium, pp. 81-87
	(2006).
2009	U.S. Patent No. 7,074,709 to Young
2010	Burckel, "3D-ICs created using oblique processing." Advances in
2010	Patterning Materials and Processes XXXIII, pp. 1–12 (2016).
2011	Declaration of Dr. E. Fred Schubert, Ph.D. in support of Patent Owner's
2011	Preliminary Response filed in IPR2016-01247 on October 7, 2016
2012	Declaration of Dr. E. Fred Schubert, Ph.D. in support of Patent Owner's
2012	Response filed in IPR2016-01246 on March 24, 2017.
	Thompson, L. F. "An Introduction to Lithography." Introduction to
2013	Microlithography, ACS Symposium Ser., American Chemical Society,
	pp. 1–13 (1983).
2014	CA1275846 C to Roland et al.

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Exhibit	Description
2015	U.S. Patent No. 5,314,843 to Yu et al.
2016	U.S. Patent No. 5,231,306 to Meikle et al.
2017	U.S. Patent No. 4,529,621 to Ballard.
2018	U.S. Patent No. 5,310,624 to Ehrlich.
2019	U.S. Patent No. 5,097,422 to Corbin, II et al.
2021	U.S. Patent No. 4,952,524 to Lee et al.
	"Structural Analysis Sample Report" downloaded from
2026	https://www.chipworks.com/TOC/Structural_Analysis_Sample_Report.
	pdf (2008).
2027	U.S. Patent No. 4,776,922 to Bhattacharyya et al.
	Subbanna, S.; Ganin, E.; Crabbé, E.; Comfort, J.; Wu, S.; Agnello, P.;
	Martin, B.; McCord, M.; Newman, H. Ng. T.; McFarland, P.; Sun, J.;
	Snare, J.; Acovic, A.; Ray, A.; Gehres, R.; Schulz, R.; Greco, S.; Beyer,
2028	K.; Liebmann, L.; DellaGuardia, R.; Lamberti, A. "200 mm Process
	Integration for a 0.15 µm Channel-Length CMOS Technology Using
	Mixed X-Ray / Optical Lithography." Proceedings of 1994 IEEE
	International Electron Devices Meeting, pp. 695–698 (1994).
	Chung, J.; Jeng, MC.; Moon, J.E.; Wu, A.T.; Chan, T.Y.; Ko, P.K.;
2029	Hu, Chenming. "Deep-Submicrometer MOS Device Fabrication Using a
	Photoresist-Ashing Technique." <i>IEEE Electron Device Letters</i> , Vol. 9.
	No. 4, pp. 186–188 (1988).
	Tanaka, Tetsu; Suzuki, Kuniniro; Horie, Hirosni; Sugii, Tosniniro.
2030	MOSEETS " 1004 Sumposium on VI SI Technology Digest of
	Technical Departs, np. 11, 12 (1004)
	Vaufman E D: Thompson D D: Proadia P E: Jaso M A: Cuthria
	W. L. : Dearson, D. L. and Small, M. B. "Chemical Mechanical
2032	Polishing for Fabricating Patterned W Metal Features as Chip
2032	Interconnects" Journal of The Flectrochemical Society, Vol. 138 No.
	11  pp 3460-3465 (1991)
	Landis H · Burke P · Cote W · Hill W · Hoffman C · Kaanta C ·
	Koburger, C.: Lange, W.: Leach, M.: and Luce, S. "Integration of
2033	chemical-mechanical polishing into CMOS integrated circuit
	manufacturing." Thin Solid Films, Vol. 220, No. 1–2, pp. 1–7 (1992).

### II. The Board should exclude paragraphs 33–159 of Patent Owner's Exhibit 2001, paragraphs 33–149 of Patent Owner's Exhibit 2011, and paragraphs 4–10 and 35–458 of Patent Owner's Exhibit 2012 as unreliable expert testimony.

The Board should exclude paragraphs 33–159 of Patent Owner's Exhibit

2001, paragraphs 33–149 of Patent Owner's Exhibit 2011, and paragraphs 4–10 and 35–458 of Exhibit 2012 because they contain unreliable testimony under Fed. R. Evid. 702 and *Daubert v. Merrell Dow Pharm., Inc.*, 509 U.S. 579 (1993). Petitioner objected to Exhibits 2001 and 2011 in objections dated January 19, 2017. Paper 13, at 2–3. Petitioner objected to Exhibit 2012 in objections dated March 31, 2017. Paper 16, at 3–4. Patent Owner relies extensively on Exhibits 2001 and 2011 throughout its Preliminary Response (Paper 7), and relies extensively on Exhibit 2012 throughout its Response (Paper 14).

Under Rule 702, an expert must be qualified in the area about which he testifies. "[T]he expert's scientific, technical, or other specialized knowledge [must] help the trier of fact to understand the evidence or to determine a fact in issue." Fed. R. Evid. 702(a). Because Dr. Schubert is not qualified to opine on shallow trench isolation in silicon MOSFET devices, the Board should not consider the opinions he expressed in paragraphs 33–159 of Patent Owner's Exhibit 2001, paragraphs 33–149 of Patent Owner's Exhibit 2011, or paragraphs 4–10 and 35–458 of Exhibit 2012.

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